

Declaration, Power of Attorney, and Petition

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

I believe I am the original, first and inventor (if plural names are listed below) of tion entitled Power MOSFET device avalanche-breakdown endurance	with reduced snap-back and	nd for which a patent is L_being_capable_d	sought on the inven-
(check one) 🔲 is attached hereto.	was filed on	as	
Application Serial No	and was amended on	······	(if applicable).
I hereby state that I have reviewed a claims, as amended by any amendment	and understand the contents of the ab	oove identified specific	cation, including the
in I acknowledge the duty to disclose ecordance with Title 37, Code of Feder	e information which is material to al Regulations, § 1.56(a).	the examination of	this application in
l hereby claim foreign priority bene patent or inventor's certificate listed belo cartificate having a filing date before the	w and have also identified below any	foreign application for	gn application(s) for patent or inventor's
	Prior Foreign Application(s)	•
apu apu		•	Priority claimed
5			
(Mumber)	(Country)	Day/month/year filed	Yes No
Comper)	(Cauntry)		<u> </u>
pak	(Country)	Day/month/year filed	Yes No
baka	#*	4	<u> </u>
골프링·	(Country)	Day/month/year filed	Yes No
I hereby claim the benefit under Titl	e 33. United States Code, § 120 of an	y United States applie	ation(s) listed below
and, insolar as the subject matter of each	ch of the claims of this application i	s not disclosed in the	prior United States
application in the manner provided by th	ie lirst paragraph of 1 itle 35. United :	States Code, § 112, 1 a	cknowledge the duty
to disclose material information as defin the filing date of the prior application a	ned in Title 37, Code of Federal Regu and the national or PCT internationa	liations, § 1.36(a) whi Il filing date of this ap	ch occurred between polication:
(Application Serial No.) (Filing date)		(Status)	(patented, pending, shandoned)
(Application Serial No.) (Filing date)	•••••••••••••••••••••••••••••••••••••••	(Status)	(petented, pending, abendoned)
I hereby declare that all statements	made herein of my own knowledge	are true and that all	statements made on
information and belief are believed to t	be true; and further that these stater	nents were made with	the knowledge that
willful false statements and the like so ma	ade are punishable by fine or impriso	nment, or both, under	Section 1001 of Title
18 of the United States Code and that su	ich willful false statements may jeopa	ardize the validity of the	he application or any
patent issued thereon.	·	,	
And I hereby appoint			

my attorney with full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith.

Wherefore I pray that Letters Patent be granted to me for the invention or discovery described and claimed in the foregoing specification and claims, and I hereby subscribe my name to the foregoing specification and claims, declaration, power of attorney, and this petition.

Full name of sole or first inventor Feng-Tso Chien	
Inventor's signature Fing. The Chien	Data 1/15/2002
Inventor's signature 7209 TG (first inventor 7209 TG) Residence No. 71, Hung-Yang Rd., Chung-Li City, Taoyuan Hsien, Taiwan, R.O.C.	Date
Citizenship	·····
Post Office Address	***************************************
Full name of record loint investor of non-	
Full name of second joint inventor, if any	~
Second Inventor's signature	Date
Residence	
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Fell name of third foint inventor, if may	······
Third! Inventor's signature	Date
Residence	
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Full name of fourth toint in actor if	
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Full name of fifth Joint inventor, if any	
Fifth Inventor's signature	n .
Residence	
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Post Office Address	
(Supply similar information and signature for third and subseque	ent joint inventors.)